



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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1. Scope of Application

These specifications apply to chip type LED lamp, CITELED, model CL-482S-HB8-SD-TS.

2. Part code

Reference

CL-482S-HB8-SD-TS

Series _____

482S : Mono-color
Ultra small, thin, sideways
light emission type

Lighting color _____

HB8 : High brightness blue
Low VF type

Diffusion _____

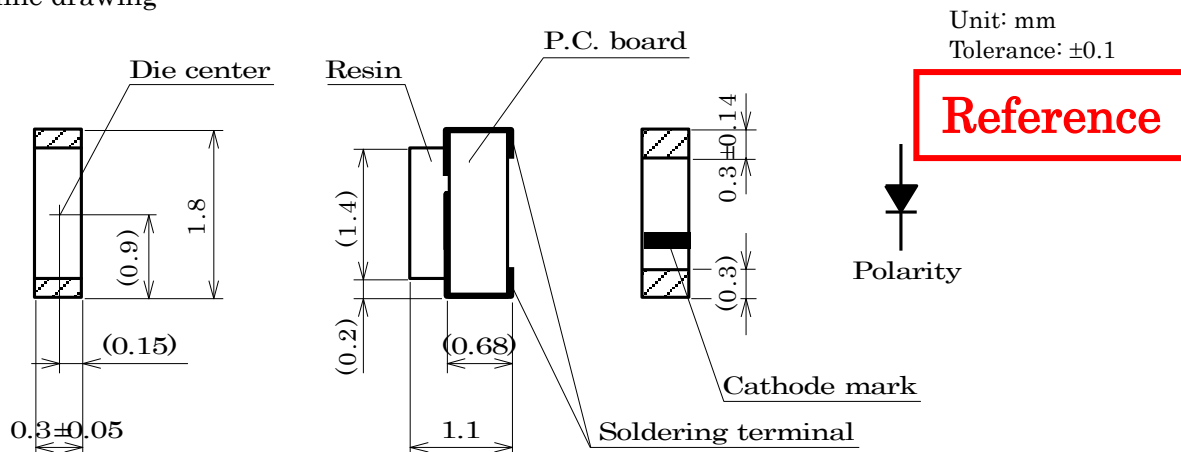
SD: Diffused

Shipping mode _____

Non-coded: Bulk
TS: Taping (standard)

			Approved	Checked	Drawn	Symbol	CITELED			
						Name	CL-482S-HB8			
						Drawing No				
Mark	Date	Description				Appro.	CITIZEN ELECTRONICS CO.,LTD.			

3. Outline drawing



4. Performance

(1) Absolute Maximum Rating (Ta=25°C)

Parameter	Symbol	Rating Value	Unit
Power Dissipation	Pd	76	mW
Forward Current	IF	20	mA
Forward Pulse Current *	IFP	50*	mA
Reverse Voltage	VR	4	V
Operating Temperature	Top	-25 ~ +80	°C
Storage Temperature	Tst	-30 ~ +85	°C

* Duty ≤ 1/10, Pulse width ≤ 0.1 msec

(2) Electro-optical Characteristic

(Ta=25°C)

Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Forward Voltage	VF	IF=5mA	—	2.9	3.24	V
Reverse Current	IR	VR=4V	—	—	2	μA
Luminous Intensity *	IV	IF=5mA	20	32	66	mcd
Dominant Wave length	λd	IF=5mA	461	470	479	nm

* In accordance with NIST standard

Note 1) The tolerance of Forward Voltage measurement is ±3% at our tester.

Note 2) The tolerance of Luminous Intensity measurement is ±10% at our tester.

Note 3) The tolerance of Dominant Wave length measurement is ±2nm at our tester.

Note 4) For handling, please apply CMOS LSI or equivalent to prevent any electrostatic effect.

Note 5) Please be aware that the above electro-optical characteristics are guaranteed when applying the current values shown in the table.

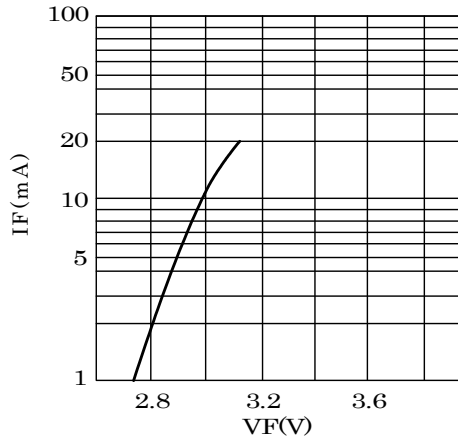
Please consult us when this product is used under any other conditions.

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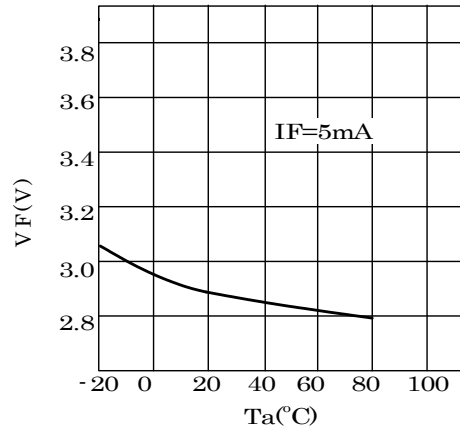
5. Characteristic

Reference

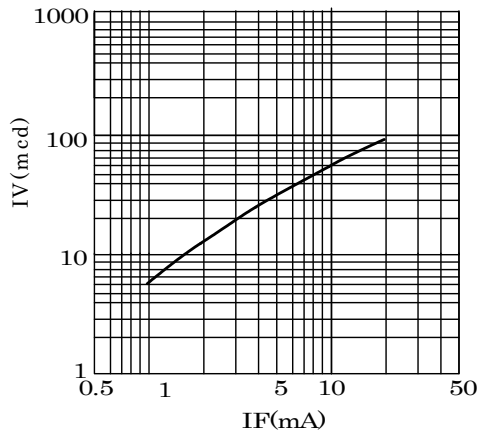
IF-VF Characteristics



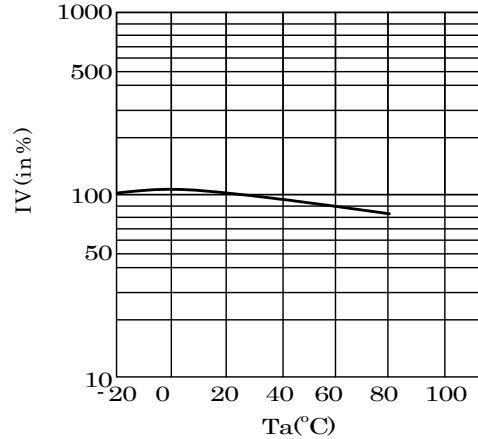
VF-Ta Characteristics



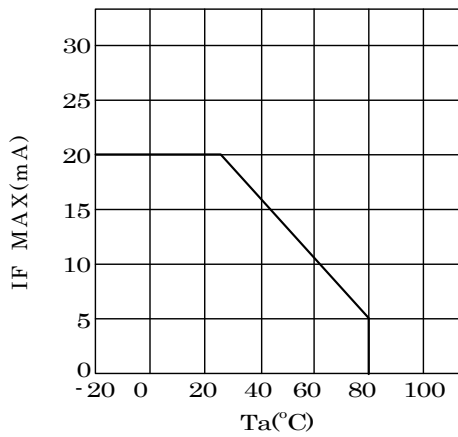
IV-IF Characteristics



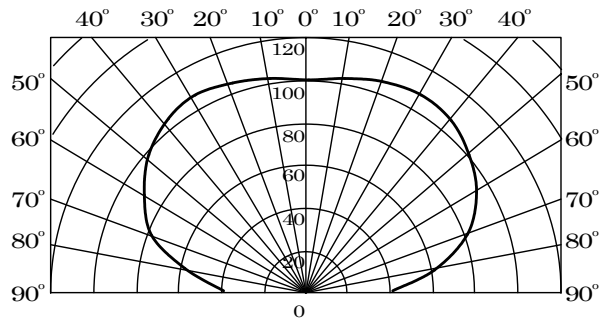
IV-Ta Characteristics



IF Max-Ta Characteristics



Directive Characteristics



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6. Reliability

Reference

(1) Details of the tests

Test Item	Test Condition
Life Test in Continuous Operation	$25 \pm 3^{\circ}\text{C}$, $I_F = 20 \text{ mA} \times 500_{-12}^{+24}$ hours
Low Temperature Storage Test	$-30_{-3}^{+3} \text{ }^{\circ}\text{C} \times 500_{-12}^{+24}$ hours
High Temperature Storage Test	$85_{-3}^{+5} \text{ }^{\circ}\text{C} \times 500_{-12}^{+24}$ hours
Moisture-proof Test	$60 \pm 2^{\circ}\text{C}$, $90 \pm 5\% \text{RH}$ for 500_{-12}^{+24} hours
Thermal Shock Test	$-30^{\circ}\text{C} \times 30 \text{ minutes} - 85^{\circ}\text{C} \times 30 \text{ minutes}$, 5-cycle
Solder Heat Resistance Test	Recommended temperature profile (reflow soldering) $\times 2$, (2 nd test must be started after the samples are stabilized thermally.)

(2) Judgment Criteria of Failure for Reliability Test

Measuring Item	Symbol	Measuring Condition	Judgement Criteria for Failure
Forward Voltage	V_F	$I_F = 5 \text{ mA}$	$>U \times 1.2$
Reverse Current	I_R	$V_R = 4 \text{ V}$	$>U \times 2$
Luminous Intensity	I_V	$I_F = 5 \text{ mA}$	$<S \times 0.5$

U means the upper limit of the specified characteristics. S means the initial value.

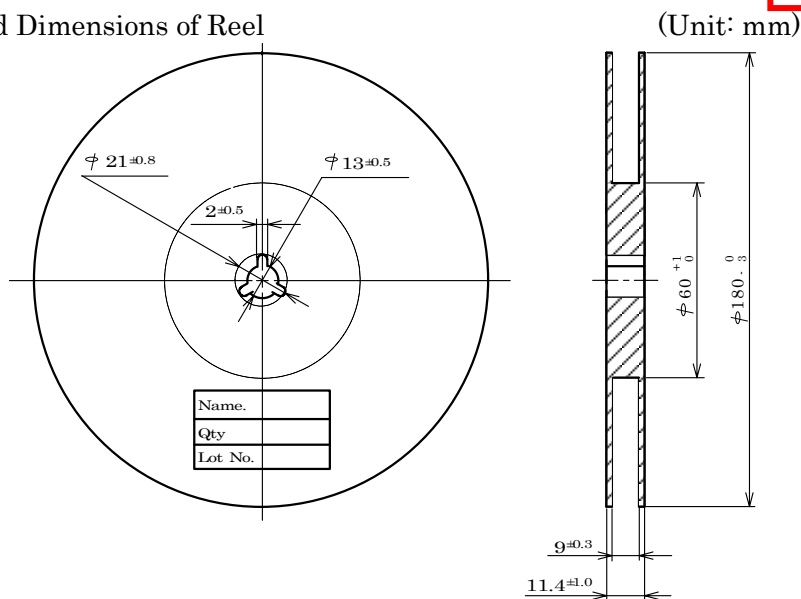
Note: Measurement shall be taken between 2 hours and 24 hours, having returned the test pieces to the normal ambient conditions after the completion of each test.

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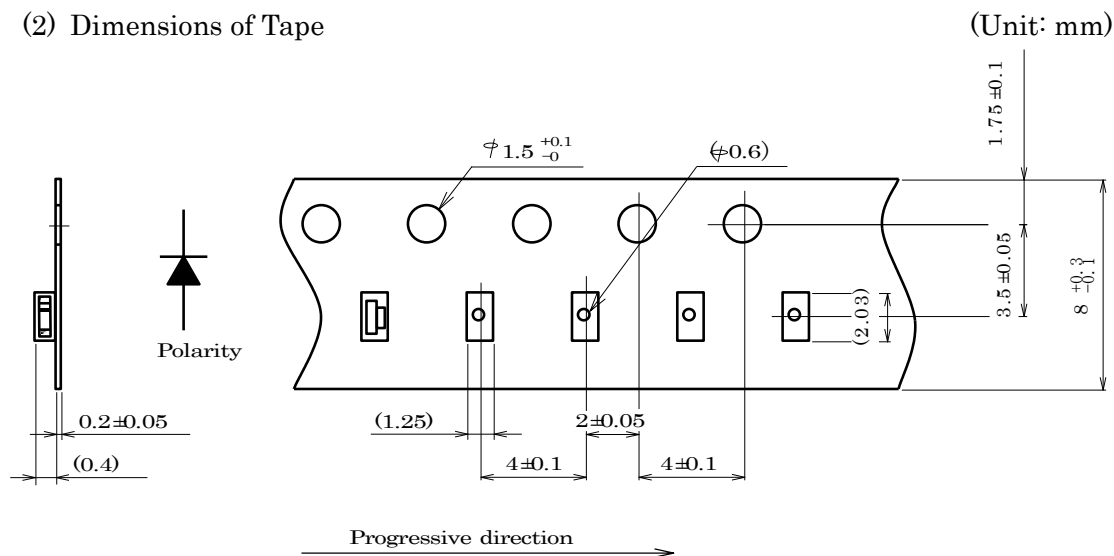
Reference

7. Taping Specifications (in accordance with JIS standard)

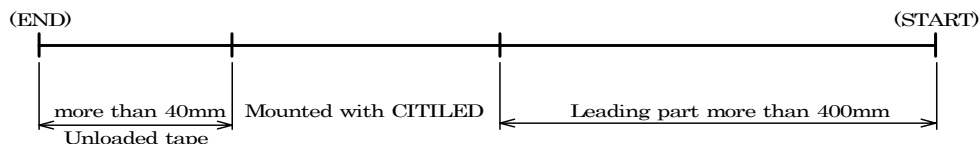
(1) Shape and Dimensions of Reel



(2) Dimensions of Tape



(3) Configuration of Tape



(4) Quantity: 5,000pcs/reel

(Please note that the shipping quantity of this product may be less than 5000 pieces per reel (minimum quantity: 1000 pieces) depending on the shipping quantity, shipping delivery date and other conditions. However, in this case, we will announce to you in advance.)

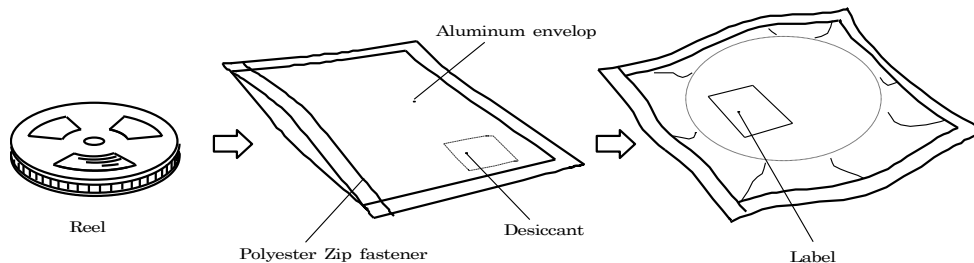
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Reference

8. Packing Specifications

8-1. Moisture-proof Packing

To prevent moisture absorption during transportation and storage, reels are packed in aluminum envelopes which contain a desiccant with a humidity indicator.



8-2. Storage

To prevent moisture absorption, it is strongly recommended that reels (in bulk or taped) should be stored in the dry box (or the desiccator) with a desiccant as the appropriate storage place. If not, the following is recommended.

Temperature: 5 ~ 30 °C
 Humidity: 60%RH max.

The devices should be mounted as soon as possible after unpacking. If you store the unpacked reels, please store them in the dry box or seal them into the envelop again.

8-3. Baking

If the devices have been stored over 6 months or unpacked over 7 days, it should be baked under the following conditions.

Baking conditions: 60°C × 12 hours or more (reeled one)
 100°C × 45 minutes or more (loose one)

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10. Precautions

Reference

10-1. Soldering

(1) Manual soldering

- 1) Solder of 96.5Sn 3Ag 0.5Cu is recommended.
- 2) Before soldering every time, make baking to units. By manual soldering, it is the possibility of crack due to the moisture absorption in the resin portion.
- 3) Use a soldering iron of 25W or smaller. Adjust the temperature of the soldering iron below 350°C.
- 4) Force or stress must not be applied to the resin portion while soldering.
- 5) Finish soldering within 3 seconds.
- 6) Handle the devices only after temperature is cooled down.

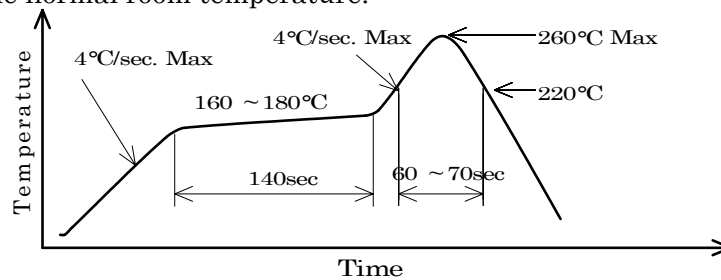
(2) Lead free soldering

- 1) Following soldering paste is recommended

Melting temperature: 216 ~ 220°C.

Composition: 96.5Sn 3Ag 0.5Cu

- 2) The temperature profile at the top surface of the parts is recommended as shown below.
- 3) It is requested that products should be handled after their temperature has dropped down to the normal room temperature.



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Reference

10-2. Washing

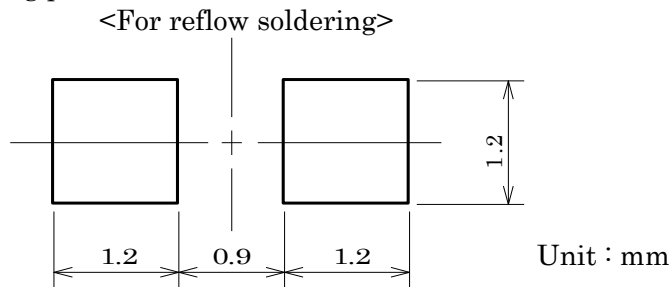
- (1) When washing after soldering is needed, following conditions are requested.
 - a) Washing solvent: Pure Water
 - b) Temperature, time: 50°C or less × 30 seconds max.
or 30°C or less × 3 minutes max.
 - c) Ultrasonic washing: 300W or less

10-3. Other directions

- (1) It is requested to avoid any stress added to the resin portion while it is heated.
- (2) It is requested to avoid any friction by sharp metal nail etc. to the resin portion.

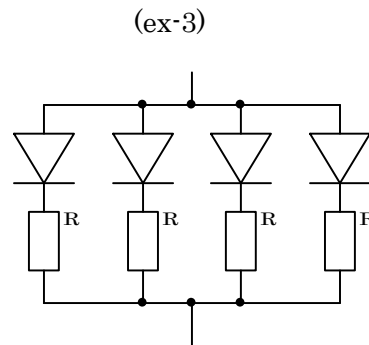
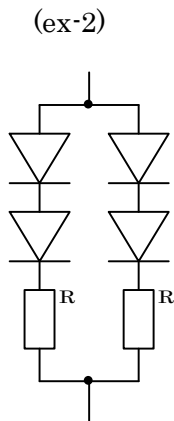
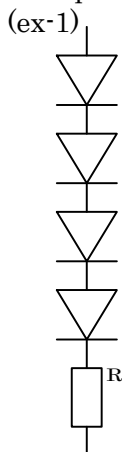
10. Designing precautions

- (1) The current limiting resistor should be placed in the circuit so that is driven within its rating. Also avoid reverse voltage (over-current) applied instantaneously when ON or OFF.
- (2) When pulse driving current is applied, average current consumption should be within the rating. Also avoid reverse voltage applied when put off.
- (3) Recommended soldering pattern



The above dimensions are not the one which guarantee the performance of mountability.
The use of the above pattern is recommended to use after deep study at your site.

- (4) When assembling the circuit board into the finished products, care must be taken to avoid the component parts from touching other parts.
- (5) When using multiple LEDs, it is required to connect a current limiting resistor on each path which the current flows to the LEDs.



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